

HSF

NOTES:

Current Rating: 1.0AMP

Contact Resistance: 20mΩ Max

Withstand Voltage: 500V AC/DC

Insulation Resistance: 1000MΩ Min

Operation Temperature: -40℃ to +105℃

Contact Material: Phosphor Bronze

Contact plating: Au over Ni

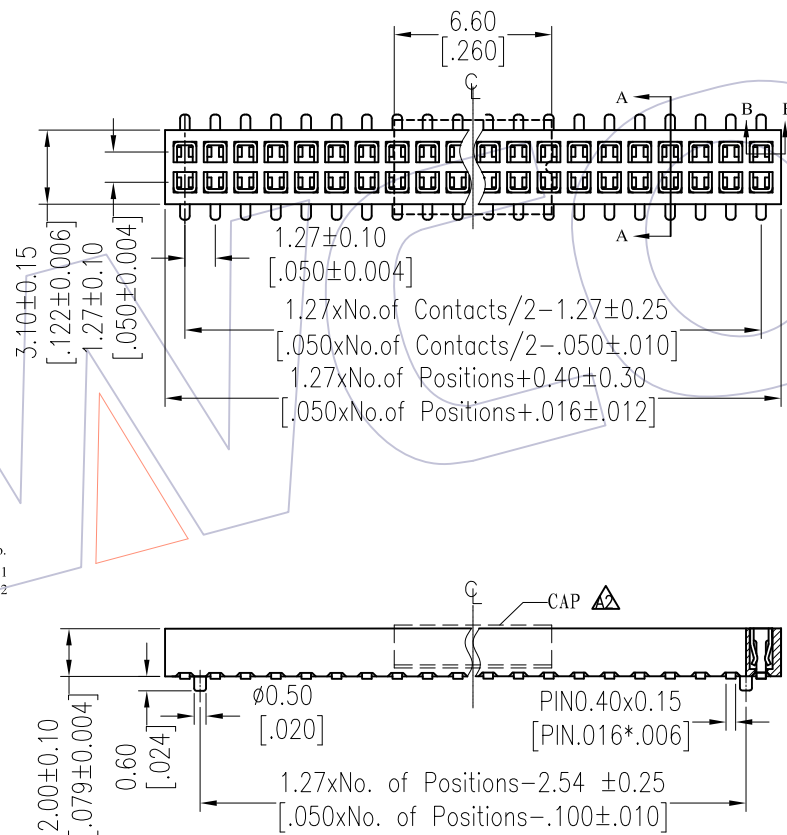
Insulator Material: PA9T+30%GF UL94V-0

Ordering Information

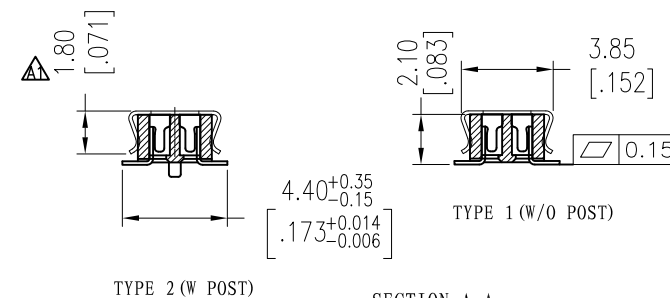
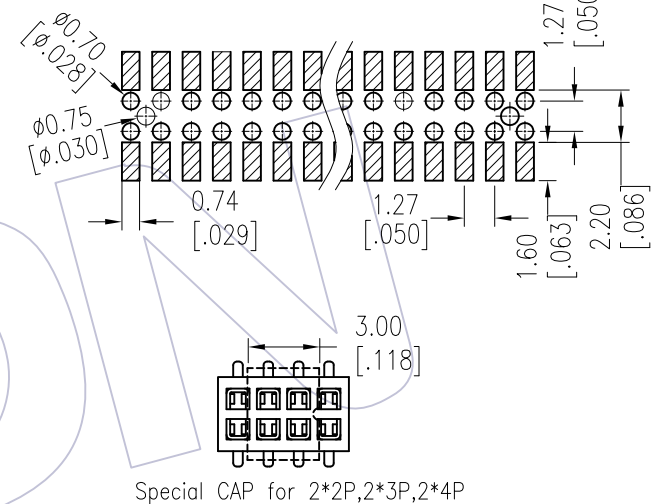
2320T - 2 XX M XX CUN T X

No. of Pins per
ROW: 02-50PINContact Plating:
G0=Gold Flash
G3=10μ"Gold
G4=15μ"Gold
G5=30μ"GoldPacking:
T=Tube
R=Tape&Reel+CAP
P=Tube+CAPSeries No.
1=TYPE 1
2=TYPE 2

Item	Pitch	Mating
Standard	1.27	1310/1315/1320
Alternate		



SECTION B-B

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

SECTION A-A

TYPE	PART NO.
TYPE 1	2320T-2XXMXXCUNX1
TYPE 2	2320T-2XXMXXCUNX2

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION	DRAW	DATE	SCALE	FIT	PART NO.
A2	2014/12/30	Modify CAP	-----	X.X ±0.40	Wang	2014/12/30	UNIT mm		SEE TABLE
A1	2013/08/20	Modify CAP 2.00 → 1.80	-----	X.XX ±0.25	CHECK	DATE	SIZE A4		TITLE: FH1.27mm Dual Bottom Enter SMT H=2.0
A0	2012/07/05	NEW	-----	X.XXX ±0.15	APPROVE	DATE	SHEET 1/1		Customer NO.
				Angle ± 3'			PROJ.		
				DIM TOL					